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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

| | |
|--------------------------------|---|
| Product Status | Active |
| Number of LABs/CLBs | 250540 |
| Number of Logic Elements/Cells | 660000 |
| Total RAM Bits | 49610752 |
| Number of I/O | 396 |
| Number of Gates | - |
| Voltage - Supply | 0.87V ~ 0.93V |
| Mounting Type | Surface Mount |
| Operating Temperature | -40°C ~ 100°C (TJ) |
| Package / Case | 1152-BBGA, FCBGA |
| Supplier Device Package | 1152-FCBGA (35x35) |
| Purchase URL | https://www.e-xfl.com/product-detail/intel/10ax066k4f35i3sg |



Key Advantages of Intel Arria 10 Devices

Table 2. Key Advantages of the Intel Arria 10 Device Family

| Advantage | Supporting Feature |
|--|---|
| Enhanced core architecture | <ul style="list-style-type: none">Built on TSMC's 20 nm process technology60% higher performance than the previous generation of mid-range FPGAs15% higher performance than the fastest previous-generation FPGA |
| High-bandwidth integrated transceivers | <ul style="list-style-type: none">Short-reach rates up to 25.8 Gigabits per second (Gbps)Backplane capability up to 12.5 GbpsIntegrated 10GBASE-KR and 40GBASE-KR4 Forward Error Correction (FEC) |
| Improved logic integration and hard IP blocks | <ul style="list-style-type: none">8-input adaptive logic module (ALM)Up to 65.6 megabits (Mb) of embedded memoryVariable-precision digital signal processing (DSP) blocksFractional synthesis phase-locked loops (PLLs)Hard PCI Express Gen3 IP blocksHard memory controllers and PHY up to 2,400 Megabits per second (Mbps) |
| Second generation hard processor system (HPS) with integrated ARM* Cortex*-A9* MPCore* processor | <ul style="list-style-type: none">Tight integration of a dual-core ARM Cortex-A9 MPCore processor, hard IP, and an FPGA in a single Intel Arria 10 system-on-a-chip (SoC)Supports over 128 Gbps peak bandwidth with integrated data coherency between the processor and the FPGA fabric |
| Advanced power savings | <ul style="list-style-type: none">Comprehensive set of advanced power saving featuresPower-optimized MultiTrack routing and core architectureUp to 40% lower power compared to previous generation of mid-range FPGAsUp to 60% lower power compared to previous generation of high-end FPGAs |

Summary of Intel Arria 10 Features

Table 3. Summary of Features for Intel Arria 10 Devices

| Feature | Description |
|------------------------------|---|
| Technology | <ul style="list-style-type: none">TSMC's 20-nm SoC process technologyAllows operation at a lower V_{CC} level of 0.82 V instead of the 0.9 V standard V_{CC} core voltage |
| Packaging | <ul style="list-style-type: none">1.0 mm ball-pitch FINELINE BGA packaging0.8 mm ball-pitch Ultra FINELINE BGA packagingMultiple devices with identical package footprints for seamless migration between different FPGA densitiesDevices with compatible package footprints allow migration to next generation high-end Stratix® 10 devicesRoHS, leaded⁽¹⁾, and lead-free (Pb-free) options |
| High-performance FPGA fabric | <ul style="list-style-type: none">Enhanced 8-input ALM with four registersImproved multi-track routing architecture to reduce congestion and improve compilation timeHierarchical core clocking architectureFine-grained partial reconfiguration |
| Internal memory blocks | <ul style="list-style-type: none">M20K—20-Kb memory blocks with hard error correction code (ECC)Memory logic array block (MLAB)—640-bit memory |
| continued... | |

⁽¹⁾ Contact Intel for availability.



| Feature | Description | |
|-----------------------------------|--|---|
| Embedded Hard IP blocks | Variable-precision DSP | <ul style="list-style-type: none">• Native support for signal processing precision levels from 18 x 19 to 54 x 54• Native support for 27 x 27 multiplier mode• 64-bit accumulator and cascade for systolic finite impulse responses (FIRs)• Internal coefficient memory banks• Padder/subtractor for improved efficiency• Additional pipeline register to increase performance and reduce power• Supports floating point arithmetic:<ul style="list-style-type: none">— Perform multiplication, addition, subtraction, multiply-add, multiply-subtract, and complex multiplication.— Supports multiplication with accumulation capability, cascade summation, and cascade subtraction capability.— Dynamic accumulator reset control.— Support direct vector dot and complex multiplication chaining multiply floating point DSP blocks. |
| | Memory controller | DDR4, DDR3, and DDR3L |
| | PCI Express* | PCI Express (PCIe*) Gen3 (x1, x2, x4, or x8), Gen2 (x1, x2, x4, or x8) and Gen1 (x1, x2, x4, or x8) hard IP with complete protocol stack, endpoint, and root port |
| | Transceiver I/O | <ul style="list-style-type: none">• 10GBASE-KR/40GBASE-KR4 Forward Error Correction (FEC)• PCS hard IPs that support:<ul style="list-style-type: none">— 10-Gbps Ethernet (10GbE)— PCIe PIPE interface— Interlaken— Gbps Ethernet (GbE)— Common Public Radio Interface (CPRI) with deterministic latency support— Gigabit-capable passive optical network (GPON) with fast lock-time support• 13.5G JESD204b• 8B/10B, 64B/66B, 64B/67B encoders and decoders• Custom mode support for proprietary protocols |
| Core clock networks | <ul style="list-style-type: none">• Up to 800 MHz fabric clocking, depending on the application:<ul style="list-style-type: none">— 667 MHz external memory interface clocking with 2,400 Mbps DDR4 interface— 800 MHz LVDS interface clocking with 1,600 Mbps LVDS interface• Global, regional, and peripheral clock networks• Clock networks that are not used can be gated to reduce dynamic power | |
| Phase-locked loops (PLLs) | <ul style="list-style-type: none">• High-resolution fractional synthesis PLLs:<ul style="list-style-type: none">— Precision clock synthesis, clock delay compensation, and zero delay buffering (ZDB)— Support integer mode and fractional mode— Fractional mode support with third-order delta-sigma modulation• Integer PLLs:<ul style="list-style-type: none">— Adjacent to general purpose I/Os— Support external memory and LVDS interfaces | |
| FPGA General-purpose I/Os (GPIOs) | <ul style="list-style-type: none">• 1.6 Gbps LVDS—every pair can be configured as receiver or transmitter• On-chip termination (OCT)• 1.2 V to 3.0 V single-ended LVTTTL/LVCMOS interfacing | |
| External Memory Interface | <ul style="list-style-type: none">• Hard memory controller— DDR4, DDR3, and DDR3L support<ul style="list-style-type: none">— DDR4—speeds up to 1,200 MHz/2,400 Mbps— DDR3—speeds up to 1,067 MHz/2,133 Mbps• Soft memory controller—provides support for RLDRAM 3⁽²⁾, QDR IV⁽²⁾, and QDR II+ | |
| continued... | | |



| Feature | Description |
|--------------------|--|
| | <ul style="list-style-type: none"> Dynamic reconfiguration of the transceivers and PLLs Fine-grained partial reconfiguration of the core fabric Active Serial x4 Interface |
| Power management | <ul style="list-style-type: none"> SmartVID Low static power device options Programmable Power Technology Intel Quartus Prime integrated power analysis |
| Software and tools | <ul style="list-style-type: none"> Intel Quartus Prime design suite Transceiver toolkit Platform Designer system integration tool DSP Builder for Intel FPGAs OpenCL™ support Intel SoC FPGA Embedded Design Suite (EDS) |

Related Information

[Intel Arria 10 Transceiver PHY Overview](#)

Provides details on Intel Arria 10 transceivers.

Intel Arria 10 Device Variants and Packages

Table 4. Device Variants for the Intel Arria 10 Device Family

| Variant | Description |
|-------------------|--|
| Intel Arria 10 GX | FPGA featuring 17.4 Gbps transceivers for short reach applications with 12.5 backplane driving capability. |
| Intel Arria 10 GT | FPGA featuring: <ul style="list-style-type: none"> 17.4 Gbps transceivers for short reach applications with 12.5 backplane driving capability. 25.8 Gbps transceivers for supporting CAUI-4 and CEI-25G applications with CFP2 and CFP4 modules. |
| Intel Arria 10 SX | SoC integrating ARM-based HPS and FPGA featuring 17.4 Gbps transceivers for short reach applications with 12.5 backplane driving capability. |

Intel Arria 10 GX

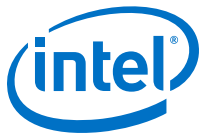
This section provides the available options, maximum resource counts, and package plan for the Intel Arria 10 GX devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Intel FPGA Product Selector.

Related Information

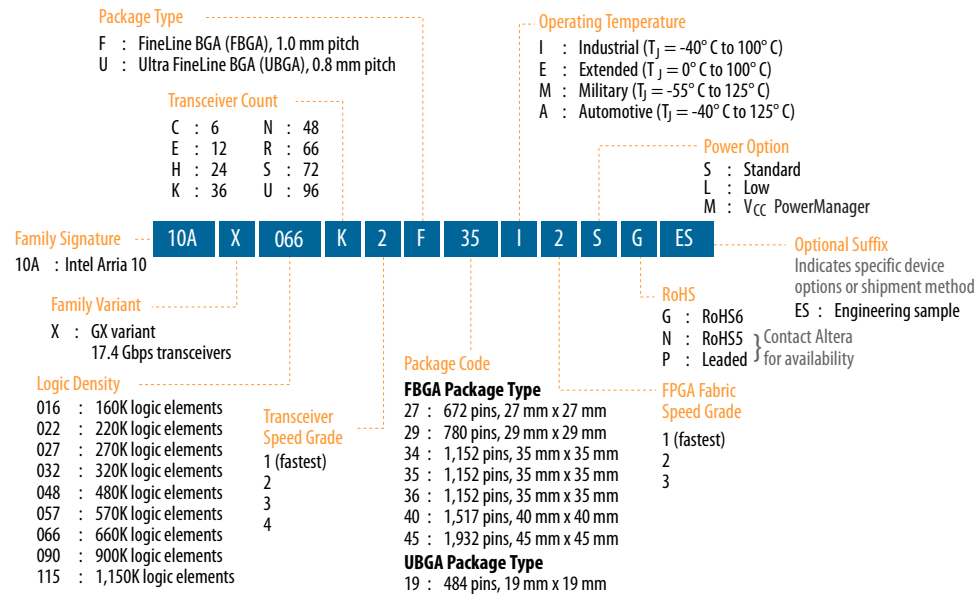
[Intel FPGA Product Selector](#)

Provides the latest information on Intel products.



Available Options

Figure 1. Sample Ordering Code and Available Options for Intel Arria 10 GX Devices



Related Information

Transceiver Performance for Intel Arria 10 GX/SX Devices

Provides more information about the transceiver speed grade.

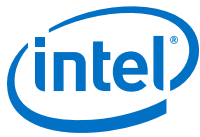


Table 6. Maximum Resource Counts for Intel Arria 10 GX Devices (GX 570, GX 660, GX 900, and GX 1150)

| Resource | | Product Line | | | |
|------------------------------|----------------------|--------------|-----------|-----------|-----------|
| | | GX 570 | GX 660 | GX 900 | GX 1150 |
| Logic Elements (LE) (K) | | 570 | 660 | 900 | 1,150 |
| ALM | | 217,080 | 251,680 | 339,620 | 427,200 |
| Register | | 868,320 | 1,006,720 | 1,358,480 | 1,708,800 |
| Memory (Kb) | M20K | 36,000 | 42,620 | 48,460 | 54,260 |
| | MLAB | 5,096 | 5,788 | 9,386 | 12,984 |
| Variable-precision DSP Block | | 1,523 | 1,687 | 1,518 | 1,518 |
| 18 x 19 Multiplier | | 3,046 | 3,374 | 3,036 | 3,036 |
| PLL | Fractional Synthesis | 16 | 16 | 32 | 32 |
| | I/O | 16 | 16 | 16 | 16 |
| 17.4 Gbps Transceiver | | 48 | 48 | 96 | 96 |
| GPIO ⁽³⁾ | | 696 | 696 | 768 | 768 |
| LVDS Pair ⁽⁴⁾ | | 324 | 324 | 384 | 384 |
| PCIe Hard IP Block | | 2 | 2 | 4 | 4 |
| Hard Memory Controller | | 16 | 16 | 16 | 16 |

Package Plan

Table 7. Package Plan for Intel Arria 10 GX Devices (U19, F27, and F29)

Refer to I/O and High Speed I/O in Intel Arria 10 Devices chapter for the number of 3 V I/O, LVDS I/O, and LVDS channels in each device package.

| Product Line | U19 (19 mm × 19 mm, 484-pin UBGA) | | | F27 (27 mm × 27 mm, 672-pin FBGA) | | | F29 (29 mm × 29 mm, 780-pin FBGA) | | |
|--------------|---|----------|------|---|----------|------|---|----------|------|
| | 3 V I/O | LVDS I/O | XCVR | 3 V I/O | LVDS I/O | XCVR | 3 V I/O | LVDS I/O | XCVR |
| GX 160 | 48 | 192 | 6 | 48 | 192 | 12 | 48 | 240 | 12 |
| GX 220 | 48 | 192 | 6 | 48 | 192 | 12 | 48 | 240 | 12 |
| GX 270 | — | — | — | 48 | 192 | 12 | 48 | 312 | 12 |
| GX 320 | — | — | — | 48 | 192 | 12 | 48 | 312 | 12 |
| GX 480 | — | — | — | — | — | — | 48 | 312 | 12 |

**Table 8. Package Plan for Intel Arria 10 GX Devices (F34, F35, NF40, and KF40)**

Refer to I/O and High Speed I/O in Intel Arria 10 Devices chapter for the number of 3 V I/O, LVDS I/O, and LVDS channels in each device package.

| Product Line | F34 (35 mm × 35 mm, 1152-pin FBGA) | | | F35 (35 mm × 35 mm, 1152-pin FBGA) | | | KF40 (40 mm × 40 mm, 1517-pin FBGA) | | | NF40 (40 mm × 40 mm, 1517-pin FBGA) | | |
|--------------|--|-------------|------|--|-------------|------|---|-------------|------|---|-------------|------|
| | 3 V I/O | LVDS I/O | XCVR | 3 V I/O | LVDS I/O | XCVR | 3 V I/O | LVDS I/O | XCVR | 3 V I/O | LVDS I/O | XCVR |
| GX 270 | 48 | 336 | 24 | 48 | 336 | 24 | — | — | — | — | — | — |
| GX 320 | 48 | 336 | 24 | 48 | 336 | 24 | — | — | — | — | — | — |
| GX 480 | 48 | 444 | 24 | 48 | 348 | 36 | — | — | — | — | — | — |
| GX 570 | 48 | 444 | 24 | 48 | 348 | 36 | 96 | 600 | 36 | 48 | 540 | 48 |
| GX 660 | 48 | 444 | 24 | 48 | 348 | 36 | 96 | 600 | 36 | 48 | 540 | 48 |
| GX 900 | — | 504 | 24 | — | — | — | — | — | — | — | 600 | 48 |
| GX 1150 | — | 504 | 24 | — | — | — | — | — | — | — | 600 | 48 |

Table 9. Package Plan for Intel Arria 10 GX Devices (RF40, NF45, SF45, and UF45)

Refer to I/O and High Speed I/O in Intel Arria 10 Devices chapter for the number of 3 V I/O, LVDS I/O, and LVDS channels in each device package.

| Product Line | RF40 (40 mm × 40 mm, 1517-pin FBGA) | | | NF45 (45 mm × 45 mm) 1932-pin FBGA) | | | SF45 (45 mm × 45 mm) 1932-pin FBGA) | | | UF45 (45 mm × 45 mm) 1932-pin FBGA) | | |
|--------------|---|-------------|------|---|-------------|------|---|-------------|------|---|-------------|------|
| | 3 V I/O | LVDS I/O | XCVR | 3 V I/O | LVDS I/O | XCVR | 3 V I/O | LVDS I/O | XCVR | 3 V I/O | LVDS I/O | XCVR |
| GX 900 | — | 342 | 66 | — | 768 | 48 | — | 624 | 72 | — | 480 | 96 |
| GX 1150 | — | 342 | 66 | — | 768 | 48 | — | 624 | 72 | — | 480 | 96 |

Related Information

[I/O and High-Speed Differential I/O Interfaces in Intel Arria 10 Devices chapter, Intel Arria 10 Device Handbook](#)

Provides the number of 3 V and LVDS I/Os, and LVDS channels for each Intel Arria 10 device package.

Intel Arria 10 GT

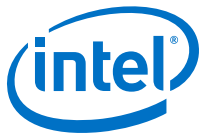
This section provides the available options, maximum resource counts, and package plan for the Intel Arria 10 GT devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Intel FPGA Product Selector.

Related Information

[Intel FPGA Product Selector](#)

Provides the latest information on Intel products.



| Product Line | U19 (19 mm × 19 mm, 484-pin UBGA) | | | F27 (27 mm × 27 mm, 672-pin FBGA) | | | F29 (29 mm × 29 mm, 780-pin FBGA) | | | F34 (35 mm × 35 mm, 1152-pin FBGA) | | |
|--------------|---|-------------|------|---|-------------|------|---|-------------|------|--|-------------|------|
| | 3 V I/O | LVDS I/O | XCVR | 3 V I/O | LVDS I/O | XCVR | 3 V I/O | LVDS I/O | XCVR | 3 V I/O | LVDS I/O | XCVR |
| SX 480 | — | — | — | — | — | — | 48 | 312 | 12 | 48 | 444 | 24 |
| SX 570 | — | — | — | — | — | — | — | — | — | 48 | 444 | 24 |
| SX 660 | — | — | — | — | — | — | — | — | — | 48 | 444 | 24 |

Table 14. Package Plan for Intel Arria 10 SX Devices (F35, KF40, and NF40)

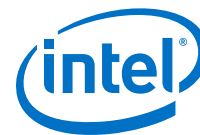
Refer to I/O and High Speed I/O in Intel Arria 10 Devices chapter for the number of 3 V I/O, LVDS I/O, and LVDS channels in each device package.

| Product Line | F35 (35 mm × 35 mm, 1152-pin FBGA) | | | KF40 (40 mm × 40 mm, 1517-pin FBGA) | | | NF40 (40 mm × 40 mm, 1517-pin FBGA) | | |
|--------------|--|----------|------|---|----------|------|---|----------|------|
| | 3 V I/O | LVDS I/O | XCVR | 3 V I/O | LVDS I/O | XCVR | 3 V I/O | LVDS I/O | XCVR |
| SX 270 | 48 | 336 | 24 | — | — | — | — | — | — |
| SX 320 | 48 | 336 | 24 | — | — | — | — | — | — |
| SX 480 | 48 | 348 | 36 | — | — | — | — | — | — |
| SX 570 | 48 | 348 | 36 | 96 | 600 | 36 | 48 | 540 | 48 |
| SX 660 | 48 | 348 | 36 | 96 | 600 | 36 | 48 | 540 | 48 |

Related Information

[I/O and High-Speed Differential I/O Interfaces in Intel Arria 10 Devices chapter, Intel Arria 10 Device Handbook](#)

Provides the number of 3 V and LVDS I/Os, and LVDS channels for each Intel Arria 10 device package.



I/O Vertical Migration for Intel Arria 10 Devices

Figure 4. Migration Capability Across Intel Arria 10 Product Lines

- The arrows indicate the migration paths. The devices included in each vertical migration path are shaded. Devices with fewer resources in the same path have lighter shades.
- To achieve the full I/O migration across product lines in the same migration path, restrict I/Os and transceivers usage to match the product line with the lowest I/O and transceiver counts.
- An LVDS I/O bank in the source device may be mapped to a 3 V I/O bank in the target device. To use memory interface clock frequency higher than 533 MHz, assign external memory interface pins only to banks that are LVDS I/O in both devices.
- There may be nominal 0.15 mm package height difference between some product lines in the same package type.
- Some migration paths are not shown in the Intel Quartus Prime software **Pin Migration View**.

| Variant | Product Line | Package | | | | | | | | | | |
|---------------------|--------------|---------|-----|-----|-----|-----|------|------|------|------|------|------|
| | | U19 | F27 | F29 | F34 | F35 | KF40 | NF40 | RF40 | NF45 | SF45 | UF45 |
| Intel® Arria® 10 GX | GX 160 | ↕ | ↕ | ↕ | | | | | | | | |
| | GX 220 | ↕ | | ↕ | | | | | | | | |
| | GX 270 | | ↕ | ↕ | ↕ | ↕ | | | | | | |
| | GX 320 | | ↕ | ↕ | ↕ | ↕ | | | | | | |
| | GX 480 | | | ↕ | ↕ | ↕ | ↕ | ↕ | | | | |
| | GX 570 | | | | ↕ | ↕ | ↕ | ↕ | | | | |
| | GX 660 | | | | ↕ | ↕ | ↕ | | ↕ | ↕ | ↕ | ↕ |
| | GX 900 | | | | ↕ | | | ↕ | ↕ | ↕ | ↕ | ↕ |
| | GX 1150 | | | | ↕ | | | ↕ | ↕ | ↕ | ↕ | ↕ |
| Intel Arria 10 GT | GT 900 | | | | | | | | | | ↕ | |
| | GT 1150 | | | | | | | | | | ↕ | |
| Intel Arria 10 SX | SX 160 | ↕ | ↕ | ↕ | | | | | | | | |
| | SX 220 | ↕ | | ↕ | | | | | | | | |
| | SX 270 | | ↕ | ↕ | ↕ | ↕ | | | | | | |
| | SX 320 | | ↕ | ↕ | ↕ | ↕ | | | | | | |
| | SX 480 | | | ↕ | ↕ | ↕ | ↕ | ↕ | | | | |
| | SX 570 | | | | ↕ | ↕ | ↕ | ↕ | | | | |
| | SX 660 | | | | ↕ | ↕ | ↕ | ↕ | | | | |

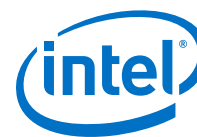
Note: To verify the pin migration compatibility, use the **Pin Migration View** window in the Intel Quartus Prime software Pin Planner.

Adaptive Logic Module

Intel Arria 10 devices use a 20 nm ALM as the basic building block of the logic fabric.

The ALM architecture is the same as the previous generation FPGAs, allowing for efficient implementation of logic functions and easy conversion of IP between the device generations.

The ALM, as shown in following figure, uses an 8-input fracturable look-up table (LUT) with four dedicated registers to help improve timing closure in register-rich designs and achieve an even higher design packing capability than the traditional two-register per LUT architecture.



Features for floating-point arithmetic:

- A completely hardened architecture that supports multiplication, addition, subtraction, multiply-add, and multiply-subtract
- Multiplication with accumulation capability and a dynamic accumulator reset control
- Multiplication with cascade summation capability
- Multiplication with cascade subtraction capability
- Complex multiplication
- Direct vector dot product
- Systolic FIR filter

Table 15. Variable-Precision DSP Block Configurations for Intel Arria 10 Devices

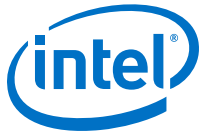
| Usage Example | Multiplier Size (Bit) | DSP Block Resources |
|---|---------------------------------|---------------------|
| Medium precision fixed point | Two 18 x 19 | 1 |
| High precision fixed or Single precision floating point | One 27 x 27 | 1 |
| Fixed point FFTs | One 19 x 36 with external adder | 1 |
| Very high precision fixed point | One 36 x 36 with external adder | 2 |
| Double precision floating point | One 54 x 54 with external adder | 4 |

Table 16. Resources for Fixed-Point Arithmetic in Intel Arria 10 Devices

The table lists the variable-precision DSP resources by bit precision for each Intel Arria 10 device.

| Variant | Product Line | Variable-precision DSP Block | Independent Input and Output Multiplications Operator | | 18 x 19 Multiplier Adder Sum Mode | 18 x 18 Multiplier Adder Summed with 36 bit Input |
|-------------------|--------------|------------------------------|---|--------------------|-----------------------------------|---|
| | | | 18 x 19 Multiplier | 27 x 27 Multiplier | | |
| Intel Arria 10 GX | GX 160 | 156 | 312 | 156 | 156 | 156 |
| | GX 220 | 192 | 384 | 192 | 192 | 192 |
| | GX 270 | 830 | 1,660 | 830 | 830 | 830 |
| | GX 320 | 984 | 1,968 | 984 | 984 | 984 |
| | GX 480 | 1,368 | 2,736 | 1,368 | 1,368 | 1,368 |
| | GX 570 | 1,523 | 3,046 | 1,523 | 1,523 | 1,523 |
| | GX 660 | 1,687 | 3,374 | 1,687 | 1,687 | 1,687 |
| | GX 900 | 1,518 | 3,036 | 1,518 | 1,518 | 1,518 |
| | GX 1150 | 1,518 | 3,036 | 1,518 | 1,518 | 1,518 |
| Intel Arria 10 GT | GT 900 | 1,518 | 3,036 | 1,518 | 1,518 | 1,518 |
| | GT 1150 | 1,518 | 3,036 | 1,518 | 1,518 | 1,518 |
| Intel Arria 10 SX | SX 160 | 156 | 312 | 156 | 156 | 156 |
| | SX 220 | 192 | 384 | 192 | 192 | 192 |
| | SX 270 | 830 | 1,660 | 830 | 830 | 830 |

continued...



| Variant | Product Line | Variable-precision DSP Block | Independent Input and Output Multiplications Operator | | 18 x 19 Multiplier Adder Sum Mode | 18 x 18 Multiplier Adder Summed with 36 bit Input |
|---------|--------------|------------------------------|---|--------------------|-----------------------------------|---|
| | | | 18 x 19 Multiplier | 27 x 27 Multiplier | | |
| | SX 320 | 984 | 1,968 | 984 | 984 | 984 |
| | SX 480 | 1,368 | 2,736 | 1,368 | 1,368 | 1,368 |
| | SX 570 | 1,523 | 3,046 | 1,523 | 1,523 | 1,523 |
| | SX 660 | 1,687 | 3,374 | 1,687 | 1,687 | 1,687 |

Table 17. Resources for Floating-Point Arithmetic in Intel Arria 10 Devices

The table lists the variable-precision DSP resources by bit precision for each Intel Arria 10 device.

| Variant | Product Line | Variable-precision DSP Block | Single Precision Floating-Point Multiplication Mode | Single-Precision Floating-Point Adder Mode | Single-Precision Floating-Point Multiply Accumulate Mode | Peak Giga Floating-Point Operations per Second (GFLOPs) |
|-------------------|--------------|------------------------------|---|--|--|---|
| Intel Arria 10 GX | GX 160 | 156 | 156 | 156 | 156 | 140 |
| | GX 220 | 192 | 192 | 192 | 192 | 173 |
| | GX 270 | 830 | 830 | 830 | 830 | 747 |
| | GX 320 | 984 | 984 | 984 | 984 | 886 |
| | GX 480 | 1,369 | 1,368 | 1,368 | 1,368 | 1,231 |
| | GX 570 | 1,523 | 1,523 | 1,523 | 1,523 | 1,371 |
| | GX 660 | 1,687 | 1,687 | 1,687 | 1,687 | 1,518 |
| | GX 900 | 1,518 | 1,518 | 1,518 | 1,518 | 1,366 |
| | GX 1150 | 1,518 | 1,518 | 1,518 | 1,518 | 1,366 |
| Intel Arria 10 GT | GT 900 | 1,518 | 1,518 | 1,518 | 1,518 | 1,366 |
| | GT 1150 | 1,518 | 1,518 | 1,518 | 1,518 | 1,366 |
| Intel Arria 10 SX | SX 160 | 156 | 156 | 156 | 156 | 140 |
| | SX 220 | 192 | 192 | 192 | 192 | 173 |
| | SX 270 | 830 | 830 | 830 | 830 | 747 |
| | SX 320 | 984 | 984 | 984 | 984 | 886 |
| | SX 480 | 1,369 | 1,368 | 1,368 | 1,368 | 1,231 |
| | SX 570 | 1,523 | 1,523 | 1,523 | 1,523 | 1,371 |
| | SX 660 | 1,687 | 1,687 | 1,687 | 1,687 | 1,518 |

Embedded Memory Blocks

The embedded memory blocks in the devices are flexible and designed to provide an optimal amount of small- and large-sized memory arrays to fit your design requirements.



Types of Embedded Memory

The Intel Arria 10 devices contain two types of memory blocks:

- 20 Kb M20K blocks—blocks of dedicated memory resources. The M20K blocks are ideal for larger memory arrays while still providing a large number of independent ports.
- 640 bit memory logic array blocks (MLABs)—enhanced memory blocks that are configured from dual-purpose logic array blocks (LABs). The MLABs are ideal for wide and shallow memory arrays. The MLABs are optimized for implementation of shift registers for digital signal processing (DSP) applications, wide and shallow FIFO buffers, and filter delay lines. Each MLAB is made up of ten adaptive logic modules (ALMs). In the Intel Arria 10 devices, you can configure these ALMs as ten 32 x 2 blocks, giving you one 32 x 20 simple dual-port SRAM block per MLAB.

Embedded Memory Capacity in Intel Arria 10 Devices

Table 18. Embedded Memory Capacity and Distribution in Intel Arria 10 Devices

| Variant | Product Line | M20K | | MLAB | | Total RAM Bit (Kb) |
|-------------------|--------------|-------|--------------|--------|--------------|--------------------|
| | | Block | RAM Bit (Kb) | Block | RAM Bit (Kb) | |
| Intel Arria 10 GX | GX 160 | 440 | 8,800 | 1,680 | 1,050 | 9,850 |
| | GX 220 | 587 | 11,740 | 2,703 | 1,690 | 13,430 |
| | GX 270 | 750 | 15,000 | 3,922 | 2,452 | 17,452 |
| | GX 320 | 891 | 17,820 | 4,363 | 2,727 | 20,547 |
| | GX 480 | 1,431 | 28,620 | 6,662 | 4,164 | 32,784 |
| | GX 570 | 1,800 | 36,000 | 8,153 | 5,096 | 41,096 |
| | GX 660 | 2,131 | 42,620 | 9,260 | 5,788 | 48,408 |
| | GX 900 | 2,423 | 48,460 | 15,017 | 9,386 | 57,846 |
| | GX 1150 | 2,713 | 54,260 | 20,774 | 12,984 | 67,244 |
| Intel Arria 10 GT | GT 900 | 2,423 | 48,460 | 15,017 | 9,386 | 57,846 |
| | GT 1150 | 2,713 | 54,260 | 20,774 | 12,984 | 67,244 |
| Intel Arria 10 SX | SX 160 | 440 | 8,800 | 1,680 | 1,050 | 9,850 |
| | SX 220 | 587 | 11,740 | 2,703 | 1,690 | 13,430 |
| | SX 270 | 750 | 15,000 | 3,922 | 2,452 | 17,452 |
| | SX 320 | 891 | 17,820 | 4,363 | 2,727 | 20,547 |
| | SX 480 | 1,431 | 28,620 | 6,662 | 4,164 | 32,784 |
| | SX 570 | 1,800 | 36,000 | 8,153 | 5,096 | 41,096 |
| | SX 660 | 2,131 | 42,620 | 9,260 | 5,788 | 48,408 |

Embedded Memory Configurations for Single-port Mode

Table 19. Single-port Embedded Memory Configurations for Intel Arria 10 Devices

This table lists the maximum configurations supported for single-port RAM and ROM modes.

| Memory Block | Depth (bits) | Programmable Width |
|--------------|--------------------|--------------------|
| MLAB | 32 | x16, x18, or x20 |
| | 64 ⁽¹⁰⁾ | x8, x9, x10 |
| M20K | 512 | x40, x32 |
| | 1K | x20, x16 |
| | 2K | x10, x8 |
| | 4K | x5, x4 |
| | 8K | x2 |
| | 16K | x1 |

Clock Networks and PLL Clock Sources

The clock network architecture is based on Intel's global, regional, and peripheral clock structure. This clock structure is supported by dedicated clock input pins, fractional clock synthesis PLLs, and integer I/O PLLs.

Clock Networks

The Intel Arria 10 core clock networks are capable of up to 800 MHz fabric operation across the full industrial temperature range. For the external memory interface, the clock network supports the hard memory controller with speeds up to 2,400 Mbps in a quarter-rate transfer.

To reduce power consumption, the Intel Quartus Prime software identifies all unused sections of the clock network and powers them down.

Fractional Synthesis and I/O PLLs

Intel Arria 10 devices contain up to 32 fractional synthesis PLLs and up to 16 I/O PLLs that are available for both specific and general purpose uses in the core:

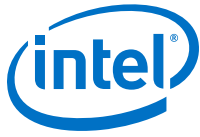
- Fractional synthesis PLLs—located in the column adjacent to the transceiver blocks
- I/O PLLs—located in each bank of the 48 I/Os

Fractional Synthesis PLLs

You can use the fractional synthesis PLLs to:

- Reduce the number of oscillators that are required on your board
- Reduce the number of clock pins that are used in the device by synthesizing multiple clock frequencies from a single reference clock source

⁽¹⁰⁾ Supported through software emulation and consumes additional MLAB blocks.



Related Information

[Intel Arria 10 Device Datasheet](#)

Lists the memory interface performance according to memory interface standards, rank or chip select configurations, and Intel Arria 10 device speed grades.

PCIe Gen1, Gen2, and Gen3 Hard IP

Intel Arria 10 devices contain PCIe hard IP that is designed for performance and ease-of-use:

- Includes all layers of the PCIe stack—transaction, data link and physical layers.
- Supports PCIe Gen3, Gen2, and Gen1 Endpoint and Root Port in x1, x2, x4, or x8 lane configuration.
- Operates independently from the core logic—optional configuration via protocol (CvP) allows the PCIe link to power up and complete link training in less than 100 ms while the Intel Arria 10 device completes loading the programming file for the rest of the FPGA.
- Provides added functionality that makes it easier to support emerging features such as Single Root I/O Virtualization (SR-IOV) and optional protocol extensions.
- Provides improved end-to-end datapath protection using ECC.
- Supports FPGA configuration via protocol (CvP) using PCIe at Gen3, Gen2, or Gen1 speed.

Related Information

[PCS Features](#) on page 30

Enhanced PCS Hard IP for Interlaken and 10 Gbps Ethernet

Interlaken Support

The Intel Arria 10 enhanced PCS hard IP provides integrated Interlaken PCS supporting rates up to 25.8 Gbps per lane.

The Interlaken PCS is based on the proven functionality of the PCS developed for Intel's previous generation FPGAs, which demonstrated interoperability with Interlaken ASSP vendors and third-party IP suppliers. The Interlaken PCS is present in every transceiver channel in Intel Arria 10 devices.

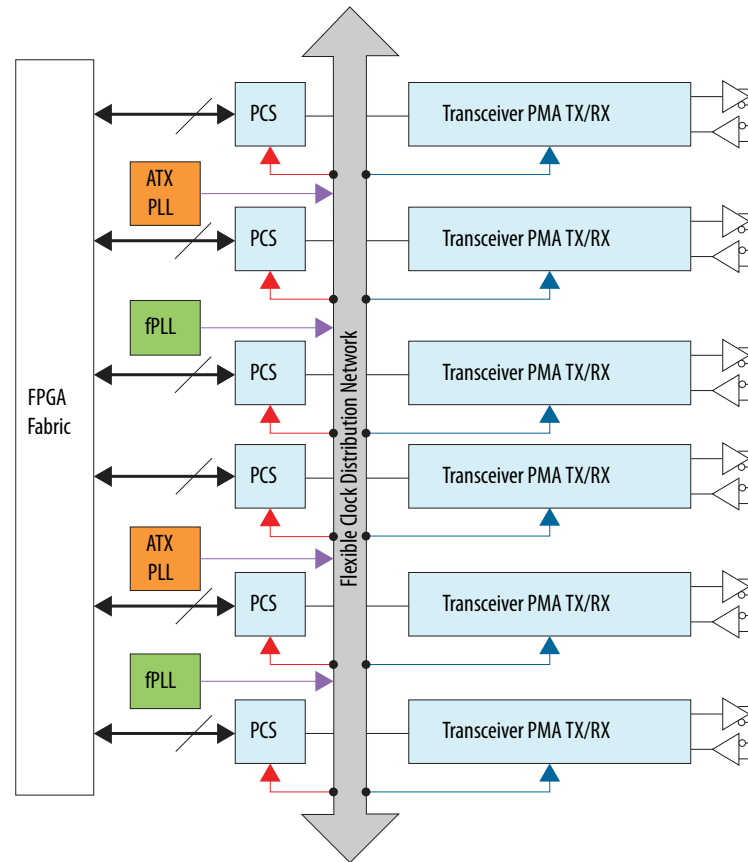
Related Information

[PCS Features](#) on page 30

10 Gbps Ethernet Support

The Intel Arria 10 enhanced PCS hard IP supports 10GBASE-R PCS compliant with IEEE 802.3 10 Gbps Ethernet (10GbE). The integrated hard IP support for 10GbE and the 10 Gbps transceivers save external PHY cost, board space, and system power.

Figure 6. Intel Arria 10 Transceiver Block Architecture



Transceiver Channels

All transceiver channels feature a dedicated Physical Medium Attachment (PMA) and a hardened Physical Coding Sublayer (PCS).

- The PMA provides primary interfacing capabilities to physical channels.
- The PCS typically handles encoding/decoding, word alignment, and other pre-processing functions before transferring data to the FPGA core fabric.

A transceiver channel consists of a PMA and a PCS block. Most transceiver banks have 6 channels. There are some transceiver banks that contain only 3 channels.

A wide variety of bonded and non-bonded data rate configurations is possible using a highly configurable clock distribution network. Up to 80 independent transceiver data rates can be configured.

The following figures are graphical representations of top views of the silicon die, which correspond to reverse views for flip chip packages. Different Intel Arria 10 devices may have different floorplans than the ones shown in the figures.



Figure 7. Device Chip Overview for Intel Arria 10 GX and GT Devices

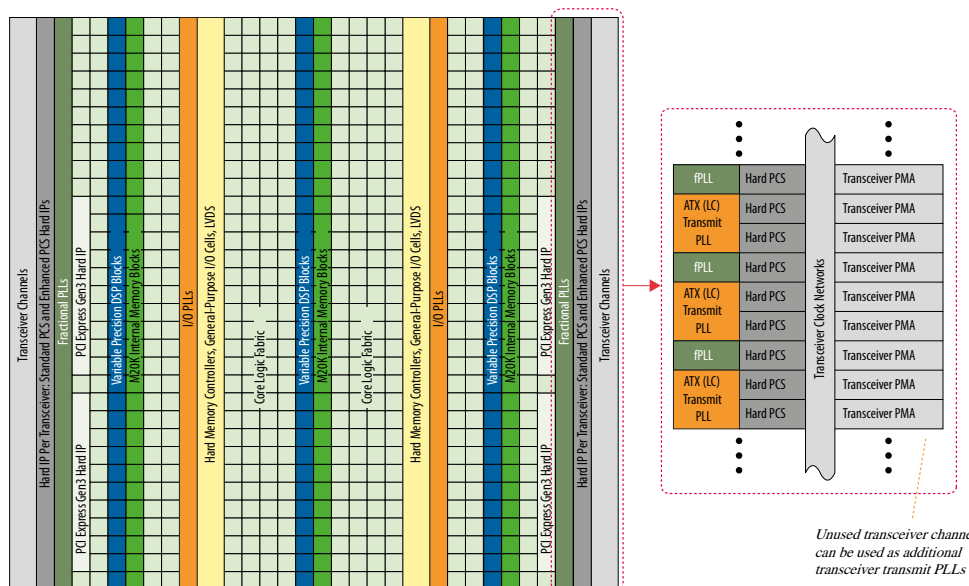
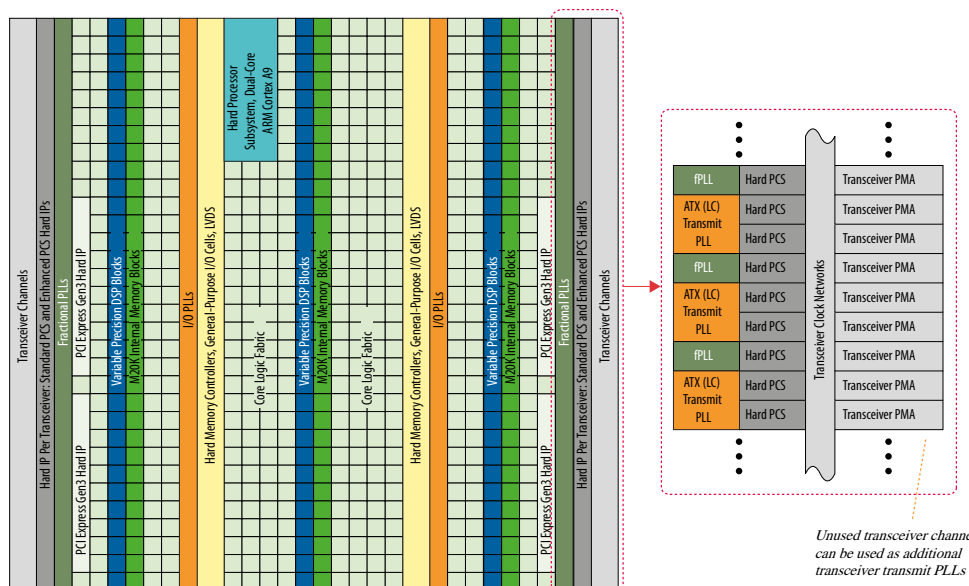


Figure 8. Device Chip Overview for Intel Arria 10 SX Devices



PMA Features

Intel Arria 10 transceivers provide exceptional signal integrity at data rates up to 25.8 Gbps. Clocking options include ultra-low jitter ATX PLLs (LC tank based), clock multiplier unit (CMU) PLLs, and fractional PLLs.



| PCS | Description |
|---------------|--|
| Standard PCS | <ul style="list-style-type: none"> Operates at a data rate up to 12 Gbps Supports protocols such as PCI-Express, CPRI 4.2+, GigE, IEEE 1588 in Hard PCS Implements other protocols using Basic/Custom (Standard PCS) transceiver configuration rules. |
| Enhanced PCS | <ul style="list-style-type: none"> Performs functions common to most serial data industry standards, such as word alignment, encoding/decoding, and framing, before data is sent or received off-chip through the PMA Handles data transfer to and from the FPGA fabric Handles data transfer internally to and from the PMA Provides frequency compensation Performs channel bonding for multi-channel low skew applications |
| PCIe Gen3 PCS | <ul style="list-style-type: none"> Supports the seamless switching of Data and Clock between the Gen1, Gen2, and Gen3 data rates Provides support for PIPE 3.0 features Supports the PIPE interface with the Hard IP enabled, as well as with the Hard IP bypassed |

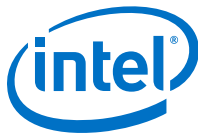
Related Information

- [PCIe Gen1, Gen2, and Gen3 Hard IP](#) on page 26
- [Interlaken Support](#) on page 26
- [10 Gbps Ethernet Support](#) on page 26

PCS Protocol Support

This table lists some of the protocols supported by the Intel Arria 10 transceiver PCS. For more information about the blocks in the transmitter and receiver data paths, refer to the related information.

| Protocol | Data Rate (Gbps) | Transceiver IP | PCS Support |
|--|------------------|-----------------------------|--------------------------------|
| PCIe Gen3 x1, x2, x4, x8 | 8.0 | Native PHY (PIPE) | Standard PCS and PCIe Gen3 PCS |
| PCIe Gen2 x1, x2, x4, x8 | 5.0 | Native PHY (PIPE) | Standard PCS |
| PCIe Gen1 x1, x2, x4, x8 | 2.5 | Native PHY (PIPE) | Standard PCS |
| 1000BASE-X Gigabit Ethernet | 1.25 | Native PHY | Standard PCS |
| 1000BASE-X Gigabit Ethernet with IEEE 1588v2 | 1.25 | Native PHY | Standard PCS |
| 10GBASE-R | 10.3125 | Native PHY | Enhanced PCS |
| 10GBASE-R with IEEE 1588v2 | 10.3125 | Native PHY | Enhanced PCS |
| 10GBASE-R with KR FEC | 10.3125 | Native PHY | Enhanced PCS |
| 10GBASE-KR and 1000BASE-X | 10.3125 | 1G/10GbE and 10GBASE-KR PHY | Standard PCS and Enhanced PCS |
| Interlaken (CEI-6G/11G) | 3.125 to 17.4 | Native PHY | Enhanced PCS |
| SFI-S/SFI-5.2 | 11.2 | Native PHY | Enhanced PCS |
| 10G SDI | 10.692 | Native PHY | Enhanced PCS |
| continued... | | | |



| Protocol | Data Rate (Gbps) | Transceiver IP | PCS Support |
|----------------------|-------------------------------|----------------|--------------|
| CPRI 6.0 (64B/66B) | 0.6144 to 10.1376 | Native PHY | Enhanced PCS |
| CPRI 4.2 (8B/10B) | 0.6144 to 9.8304 | Native PHY | Standard PCS |
| OBSAI RP3 v4.2 | 0.6144 to 6.144 | Native PHY | Standard PCS |
| SD-SDI/HD-SDI/3G-SDI | 0.143 ⁽¹²⁾ to 2.97 | Native PHY | Standard PCS |

Related Information

[Intel Arria 10 Transceiver PHY User Guide](#)

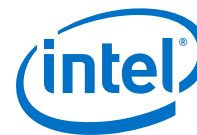
Provides more information about the supported transceiver protocols and PHY IP, the PMA architecture, and the standard, enhanced, and PCIe Gen3 PCS architecture.

SoC with Hard Processor System

Each SoC device combines an FPGA fabric and a hard processor system (HPS) in a single device. This combination delivers the flexibility of programmable logic with the power and cost savings of hard IP in these ways:

- Reduces board space, system power, and bill of materials cost by eliminating a discrete embedded processor
- Allows you to differentiate the end product in both hardware and software, and to support virtually any interface standard
- Extends the product life and revenue through in-field hardware and software updates

⁽¹²⁾ The 0.143 Gbps data rate is supported using oversampling of user logic that you must implement in the FPGA fabric.



Features of the HPS

The HPS has the following features:

- 1.2-GHz, dual-core ARM Cortex-A9 MPCore processor with up to 1.5-GHz via overdrive
 - ARMv7-A architecture that runs 32-bit ARM instructions, 16-bit and 32-bit Thumb instructions, and 8-bit Java byte codes in Jazelle style
 - Superscalar, variable length, out-of-order pipeline with dynamic branch prediction
 - Instruction Efficiency 2.5 MIPS/MHz, which provides total performance of 7500 MIPS at 1.5 GHz
- Each processor core includes:
 - 32 KB of L1 instruction cache, 32 KB of L1 data cache
 - Single- and double-precision floating-point unit and NEON media engine
 - CoreSight debug and trace technology
 - Snoop Control Unit (SCU) and Acceleration Coherency Port (ACP)
- 512 KB of shared L2 cache
- 256 KB of scratch RAM
- Hard memory controller with support for DDR3, DDR4 and optional error correction code (ECC) support
- Multiport Front End (MPFE) Scheduler interface to the hard memory controller
- 8-channel direct memory access (DMA) controller
- QSPI flash controller with SIO, DIO, QIO SPI Flash support
- NAND flash controller (ONFI 1.0 or later) with DMA and ECC support, updated to support 8 and 16-bit Flash devices and new command DMA to offload CPU for fast power down recovery
- Updated SD/SDIO/MMC controller to eMMC 4.5 with DMA with CE-ATA digital command support
- 3 10/100/1000 Ethernet media access control (MAC) with DMA
- 2 USB On-the-Go (OTG) controllers with DMA
- 5 I²C controllers (3 can be used by EMAC for MIO to external PHY)
- 2 UART 16550 Compatible controllers
- 4 serial peripheral interfaces (SPI) (2 Master, 2 Slaves)
- 62 programmable general-purpose I/Os, which includes 48 direct share I/Os that allows the HPS peripherals to connect directly to the FPGA I/Os
- 7 general-purpose timers
- 4 watchdog timers
- Anti-tamper, Secure Boot, Encryption (AES) and Authentication (SHA)



Instead of placing all device functions in the FPGA fabric, you can store some functions that do not run simultaneously in external memory and load them only when required. This capability increases the effective logic density of the device, and lowers cost and power consumption.

In the Intel solution, you do not have to worry about intricate device architecture to perform a partial reconfiguration. The partial reconfiguration capability is built into the Intel Quartus Prime design software, making such time-intensive task simple.

Intel Arria 10 devices support partial reconfiguration in the following configuration options:

- Using an internal host:
 - All supported configuration modes where the FPGA has access to external memory devices such as serial and parallel flash memory.
 - Configuration via Protocol [CvP (PCIe)]
- Using an external host—passive serial (PS), fast passive parallel (FPP) x8, FPP x16, and FPP x32 I/O interface.

Enhanced Configuration and Configuration via Protocol

Table 25. Configuration Schemes and Features of Intel Arria 10 Devices

Intel Arria 10 devices support 1.8 V programming voltage and several configuration schemes.

| Scheme | Data Width | Max Clock Rate (MHz) | Max Data Rate (Mbps) ⁽¹³⁾ | Decompression | Design Security ⁽¹⁴⁾ | Partial Reconfiguration ⁽¹⁵⁾ | Remote System Update |
|--|---------------|----------------------|--------------------------------------|---------------|---------------------------------|---|-------------------------------------|
| JTAG | 1 bit | 33 | 33 | — | — | Yes ⁽¹⁶⁾ | — |
| Active Serial (AS) through the EPCQ-L configuration device | 1 bit, 4 bits | 100 | 400 | Yes | Yes | Yes ⁽¹⁶⁾ | Yes |
| Passive serial (PS) through CPLD or external microcontroller | 1 bit | 100 | 100 | Yes | Yes | Yes ⁽¹⁶⁾ | Parallel Flash Loader (PFL) IP core |
| <i>continued...</i> | | | | | | | |

⁽¹³⁾ Enabling either compression or design security features affects the maximum data rate. Refer to the Intel Arria 10 Device Datasheet for more information.

⁽¹⁴⁾ Encryption and compression cannot be used simultaneously.

⁽¹⁵⁾ Partial reconfiguration is an advanced feature of the device family. If you are interested in using partial reconfiguration, contact Intel for support.

⁽¹⁶⁾ Partial configuration can be performed only when it is configured as internal host.



| Date | Version | Changes |
|---------------|------------|--|
| August 2014 | 2014.08.18 | <ul style="list-style-type: none"> Updated Memory (Kb) M20K maximum resources for Arria 10 GX 660 devices from 42,660 to 42,620. Added GPIO columns consisting of LVDS I/O Bank and 3V I/O Bank in the Package Plan table. Added how to use memory interface clock frequency higher than 533 MHz in the I/O vertical migration. Added information to clarify that RLDRAM3 support uses hard PHY with soft memory controller. Added variable precision DSP blocks support for floating-point arithmetic. |
| June 2014 | 2014.06.19 | Updated number of dedicated I/Os in the HPS block to 17. |
| February 2014 | 2014.02.21 | Updated transceiver speed grade options for GT devices in Figure 2. |
| February 2014 | 2014.02.06 | Updated data rate for Arria 10 GT devices from 28.1 Gbps to 28.3 Gbps. |
| December 2013 | 2013.12.10 | <ul style="list-style-type: none"> Updated the HPS memory standards support from LPDDR2 to LPDDR3. Updated HPS block diagram to include dedicated HPS I/O and FPGA Configuration blocks as well as repositioned SD/SDIO/MMC, DMA, SPI and NAND Flash with ECC blocks . |
| December 2013 | 2013.12.02 | Initial release. |